# HEF4001B-Q100

Quad 2-input NOR gate Rev. 1 — 20 February 2013

#### **General description** 1.

The HEF4001B-Q100 is a quad 2-input NOR gate. The outputs are fully buffered for the highest noise immunity and pattern insensitivity to output impedance.

It operates over a recommended  $V_{DD}$  power supply range of 3 V to 15 V referenced to  $V_{SS}$ (usually ground). Unused inputs must be connected to V<sub>DD</sub>, V<sub>SS</sub>, or another input.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### Features and benefits 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Complies with JEDEC standard JESD 13-B
- Inputs and outputs are protected against electrostatic effects

#### 3. **Ordering information**

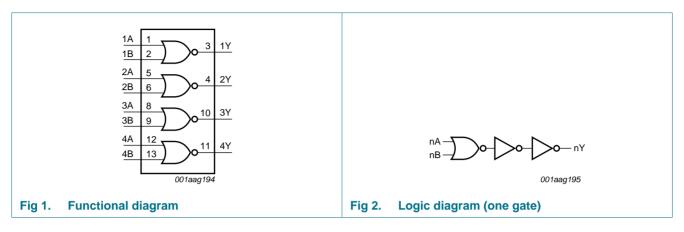
Table 1. **Ordering information** 

All types operate from -40 °C to +125 °C

Type number	Packa	Package						
	Name	Description	Version					
HEF4001BT-Q100	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1					

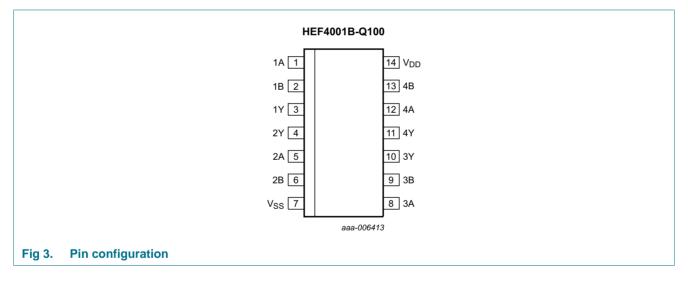


### 4. Functional diagram



# 5. Pinning information

#### 5.1 Pinning



#### 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
nA	1, 5, 8, 12	input
nB	2, 6, 9, 13	input
nY	3, 4, 10, 11	output
$V_{SS}$	7	ground (0 V)
V <sub>DD</sub>	14	supply voltage

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HEF4001B_Q100
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### 6. Functional description

Table 3.	Function table <sup>[1]</sup>		
			Output
nA		nB	nY
L		L	Н
L		Н	L
Н		L	L
Н		Н	L

[1] H = HIGH voltage level; L = LOW voltage level.

### 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 V$  (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DD</sub>	supply voltage		-0.5	+18	V
I <sub>IK</sub>	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	$V_{DD} + 0.5$	V
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
I <sub>I/O</sub>	input/output current		-	±10	mA
I <sub>DD</sub>	supply current		-	50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+125	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to + 125 \ ^{\circ}C$	<u>[1]</u> -	500	mW
Р	power dissipation	per output	-	100	mW

[1] For SO14 packages: above  $T_{amb} = 70 \text{ °C}$ ,  $P_{tot}$  derates linearly with 8 mW/K.

# 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DD</sub>	supply voltage		3	-	15	V
VI	input voltage		0	-	$V_{DD}$	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V <sub>DD</sub> = 10 V	-	-	0.5	μs/V
		V <sub>DD</sub> = 15 V	-	-	0.08	μs/V

### 9. Static characteristics

#### Table 6. Static characteristics

 $V_{SS} = 0$  V;  $V_{I} = V_{SS}$  or  $V_{DD}$ ; unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>DD</sub>	T <sub>amb</sub> =	–40 °C	T <sub>amb</sub> =	+25 °C	T <sub>amb</sub> =	+85 °C	T <sub>amb</sub> = ·	+125 °C	Unit
				Min	Max	Min	Мах	Min	Max	Min	Max	-
VIH	HIGH-level	I <sub>O</sub>   < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V <sub>IL</sub>	LOW-level	$ I_0  < 1 \ \mu A$	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
V <sub>OH</sub>	HIGH-level	$ I_0  < 1 \ \mu A$	5 V	4.95	-	4.95	-	4.95	-	4.95	-	V
	output voltage		10 V	9.95	-	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	14.95	-	V
V <sub>OL</sub>	LOW-level	$ I_0  < 1 \ \mu A$	5 V	-	0.05	-	0.05	-	0.05	-	0.05	V
	output voltage	ltage	10 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	-	0.05	V
I <sub>OH</sub>	HIGH-level output current	$V_O = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
		$V_O = 4.6 V$	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		$V_O = 9.5 V$	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		V <sub>O</sub> = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA
l <sub>OL</sub>	LOW-level	$V_{O} = 0.4 V$	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
	output current	$V_O = 0.5 V$	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		$V_{O} = 1.5 V$	15 V	4.2	-	3.4	-	2.4	-	2.4	-	mA
lı	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>DD</sub>	supply current	all valid input	5 V	-	0.25	-	0.25	-	7.5	-	7.5	μA
		combinations; I <sub>O</sub> = 0 A	10 V	-	0.5	-	0.5	-	15.0	-	15.0	μA
		10 – U A	15 V	-	1.0	-	1.0	-	30.0	-	30.0	μA
CI	input capacitance			-	-	-	7.5	-	-	-	-	pF

### **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

 $T_{amb} = 25 \text{ °C}$ ; for waveforms see Figure 4; for test circuit see Figure 5; unless otherwise specified.

Parameter	Extrapolation formula <sup>[1]</sup>	V <sub>DD</sub>	Min	Тур	Max	Unit
HIGH to LOW propagation delay	$33 \textbf{+} 0.55 \times C_L$	5 V	-	60	120	ns
	$14 + 0.23 \times C_L$	10 V	-	25	50	ns
	$12 + 0.16 \times C_L$	15 V	-	20	40	ns
LOW to HIGH propagation delay	$23 \textbf{+} 0.55 \times C_L$	5 V	-	50	100	ns
	$14 + 0.23 \times C_L$	10 V	-	25	45	ns
	$12 + 0.16 \times C_L$	15 V	-	20	35	ns
HIGH to LOW output transition time	$10 + 1.00 \times C_L$	5 V	-	60	120	ns
	$9 + 0.42 \times C_L$	10 V	-	30	60	ns
	$6 + 0.28 \times C_L$	15 V	-	20	40	ns
LOW to HIGH output transition time	$10 + 1.00 \times C_L$	5 V	-	60	120	ns
	$9 + 0.42 \times C_L$	10 V	-	30	60	ns
	$6 + 0.28 \times C_L$	15 V	-	20	40	ns
	LOW to HIGH propagation delay HIGH to LOW output transition time	$\begin{array}{l} \mbox{HIGH to LOW propagation delay} \\ \mbox{HIGH to LOW propagation delay} \\ \mbox{14 + 0.23 \times C_L} \\ \mbox{12 + 0.16 \times C_L} \\ \mbox{12 + 0.16 \times C_L} \\ \mbox{14 + 0.23 \times C_L} \\ \mbox{12 + 0.16 \times C_L} \\ \mbox{13 + 0.23 \times C_L} \\ \mbox{14 + 0.23 \times C_L} \\ 14 + $	$\begin{array}{l} \mbox{HIGH to LOW propagation delay} & 33 + 0.55 \times C_L & 5 \ V \\ \hline 14 + 0.23 \times C_L & 10 \ V \\ \hline 12 + 0.16 \times C_L & 15 \ V \\ \hline 12 + 0.16 \times C_L & 5 \ V \\ \hline 14 + 0.23 \times C_L & 10 \ V \\ \hline 12 + 0.16 \times C_L & 10 \ V \\ \hline 12 + 0.16 \times C_L & 15 \ V \\ \hline 14 + 0.23 \times C_L & 10 \ V \\ \hline 12 + 0.16 \times C_L & 5 \ V \\ \hline 14 + 0.23 \times C_L & 10 \ V \\ \hline 12 + 0.16 \times C_L & 5 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 9 + 0.42 \times C_L & 10 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 9 + 0.42 \times C_L & 10 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 10 + 1.00 \times C_L & 5 \ V \\ \hline 10 + 0.42 \times C_L & 10 \ V \\ \hline 10 + 0 + 0.42 \times C_L & 10 \ V \\ \hline 10 + 0 + 0 + 0 \ C_L & 10 \ V \\ \hline 10 + 0$	$\begin{array}{c c c c c c c c } \mbox{HIGH to LOW propagation delay} & 33 + 0.55 \times C_L & 5 \ V & - \\ \hline 14 + 0.23 \times C_L & 10 \ V & - \\ \hline 12 + 0.16 \times C_L & 15 \ V & - \\ \hline 12 + 0.16 \times C_L & 5 \ V & - \\ \hline 14 + 0.23 \times C_L & 10 \ V & - \\ \hline 14 + 0.23 \times C_L & 10 \ V & - \\ \hline 12 + 0.16 \times C_L & 15 \ V & - \\ \hline 12 + 0.16 \times C_L & 15 \ V & - \\ \hline 12 + 0.16 \times C_L & 5 \ V & - \\ \hline 10 + 1.00 \times C_L & 5 \ V & - \\ \hline 9 + 0.42 \times C_L & 10 \ V & - \\ \hline 10 + 1.00 \times C_L & 5 \ V & - \\ \hline 10 + 0.28 \times C_L & 15 \ V & - \\ \hline 10 + 0.28 \times C_L & 15 \ V & - \\ \hline 10 + 0.28 \times C_L & 15 \ V & - \\ \hline 10 + 0.28 \times C_L & 10 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \ V & - \\ \hline 10 + 0 + 0 \$	$\begin{array}{cccccc} \text{HIGH to LOW propagation delay} & 33 \pm 0.55 \times \text{C}_{\text{L}} & 5 \text{V} & - & 60 \\ \hline 14 \pm 0.23 \times \text{C}_{\text{L}} & 10 \text{V} & - & 25 \\ \hline 12 \pm 0.16 \times \text{C}_{\text{L}} & 15 \text{V} & - & 20 \\ \hline 12 \pm 0.16 \times \text{C}_{\text{L}} & 5 \text{V} & - & 50 \\ \hline 14 \pm 0.23 \times \text{C}_{\text{L}} & 10 \text{V} & - & 25 \\ \hline 12 \pm 0.16 \times \text{C}_{\text{L}} & 10 \text{V} & - & 25 \\ \hline 12 \pm 0.16 \times \text{C}_{\text{L}} & 15 \text{V} & - & 20 \\ \hline 14 \pm 0.23 \times \text{C}_{\text{L}} & 10 \text{V} & - & 25 \\ \hline 12 \pm 0.16 \times \text{C}_{\text{L}} & 15 \text{V} & - & 20 \\ \hline 14 \pm 0.23 \times \text{C}_{\text{L}} & 10 \text{V} & - & 20 \\ \hline 14 \pm 0.23 \times \text{C}_{\text{L}} & 10 \text{V} & - & 20 \\ \hline 14 \pm 0.23 \times \text{C}_{\text{L}} & 15 \text{V} & - & 20 \\ \hline 14 \pm 0.23 \times \text{C}_{\text{L}} & 15 \text{V} & - & 20 \\ \hline 10 \pm 1.00 \times \text{C}_{\text{L}} & 5 \text{V} & - & 60 \\ \hline 9 \pm 0.42 \times \text{C}_{\text{L}} & 10 \text{V} & - & 30 \\ \hline 6 \pm 0.28 \times \text{C}_{\text{L}} & 15 \text{V} & - & 20 \\ \hline \text{LOW to HIGH output transition time} & 10 \pm 1.00 \times \text{C}_{\text{L}} & 5 \text{V} & - & 60 \\ \hline 9 \pm 0.42 \times \text{C}_{\text{L}} & 10 \text{V} & - & 30 \\ \hline 9 \pm 0.42 \times \text{C}_{\text{L}} & 10 \text{V} & - & 30 \\ \hline \end{array}$	$\begin{array}{ccccccc} \mbox{HIGH to LOW propagation delay} & 33 \pm 0.55 \times C_L & 5 \mbox{ V} & - & 60 & 120 \\ \hline 14 \pm 0.23 \times C_L & 10 \mbox{ V} & - & 25 & 50 \\ \hline 12 \pm 0.16 \times C_L & 15 \mbox{ V} & - & 20 & 40 \\ \hline 12 \pm 0.16 \times C_L & 5 \mbox{ V} & - & 50 & 100 \\ \hline 14 \pm 0.23 \times C_L & 10 \mbox{ V} & - & 25 & 45 \\ \hline 12 \pm 0.16 \times C_L & 15 \mbox{ V} & - & 20 & 35 \\ \hline 12 \pm 0.16 \times C_L & 15 \mbox{ V} & - & 20 & 35 \\ \hline HIGH to LOW output transition time & 10 \pm 1.00 \times C_L & 5 \mbox{ V} & - & 60 & 120 \\ \hline 9 \pm 0.42 \times C_L & 10 \mbox{ V} & - & 30 & 60 \\ \hline 10 \pm 1.00 \times C_L & 5 \mbox{ V} & - & 60 & 120 \\ \hline 9 \pm 0.42 \times C_L & 10 \mbox{ V} & - & 30 & 60 \\ \hline \end{array}$

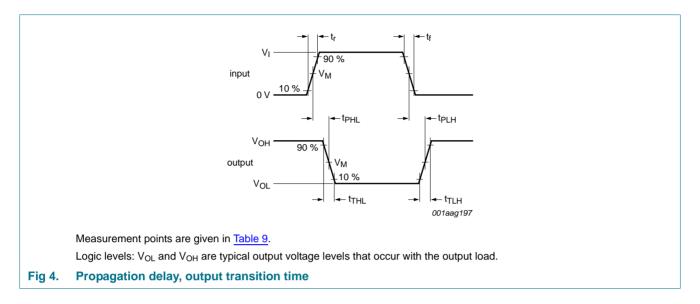
[1] The typical value of the propagation delay and output transition time can be calculated with the extrapolation formula (C<sub>L</sub> in pF).

#### Table 8. Dynamic power dissipation

 $V_{SS} = 0$  V;  $t_r = t_f \le 20$  ns;  $T_{amb} = 25$  °C.

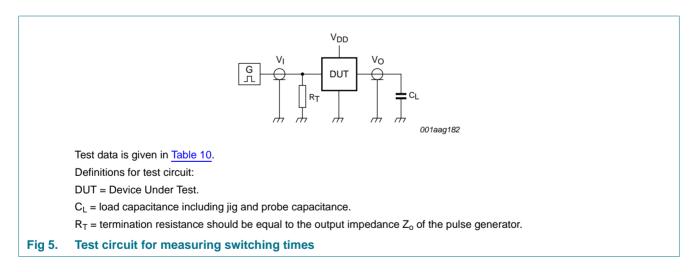
Symbol	Parameter	$\mathbf{V}_{\text{DD}}$	Typical formula	Where
PD	dynamic power dissipation	5 V	$\textbf{P}_{D} = \textbf{1100} \times \textbf{f}_{i} + \boldsymbol{\Sigma}(\textbf{f}_{o} \times \textbf{C}_{L}) \times \textbf{V}_{DD}{}^{2} \ (\mu \textbf{W})$	$f_i$ = input frequency in MHz;
			$P_D = 5000 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2 \; (\muW)$	
		15 V	$P_D = 14200 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2 \ (\muW)$	$C_L$ = output load capacitance in pF;
				$\Sigma(f_o \times C_L)$ = sum of the outputs;
				$V_{DD}$ = supply voltage in V.

### 11. Waveforms



#### Table 9.Measurement points

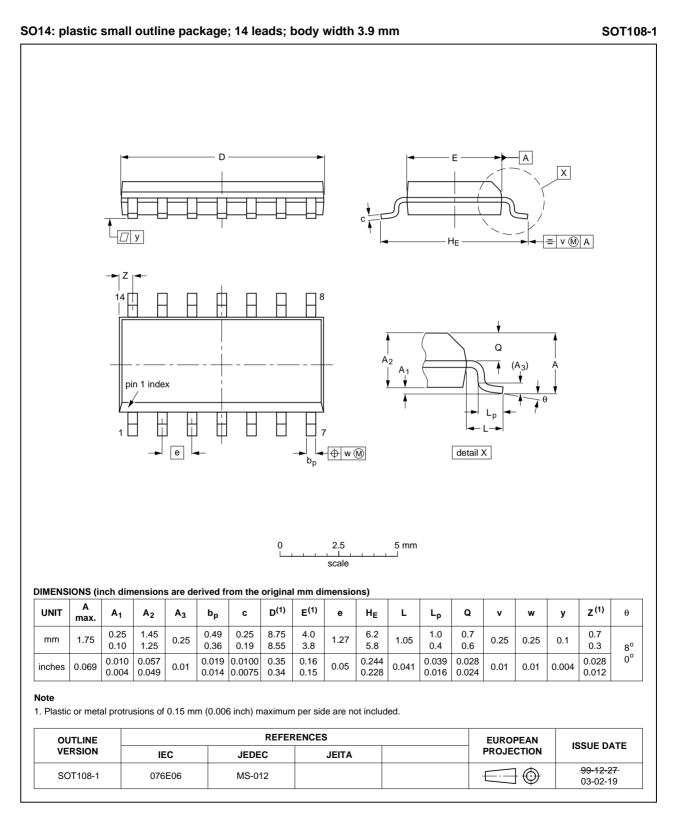
Supply voltage	Input	Output
V <sub>DD</sub>	V <sub>M</sub>	V <sub>M</sub>
5 V to 15 V	0.5V <sub>DD</sub>	0.5V <sub>DD</sub>



#### Table 10. Test data

Supply voltage	Input	Load	
V <sub>DD</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL
5 V to 15 V	V <sub>SS</sub> or V <sub>DD</sub>	≤ 20 ns	50 pF

### 12. Package outline



#### Fig 6. Package outline SOT108-1 (SO14)

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### **13. Abbreviations**

Table 11. At	bbreviations
Acronym	Description
HBM	Human Body Model
ESD	ElectroStatic Discharge
MM	Machine Model
MIL	Military

# 14. Revision history

Table 12. Revision history								
Document ID	Release date	Data sheet status	Change notice	Supersedes				
HEF4001B_Q100 v.1	20130220	Product data sheet	-	-				

## 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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